



DMT67M8LPSW

## **Product Summary**

BV <sub>DSS</sub>	Rds(on) max	Ι <sub>D MAX</sub> T <sub>C</sub> = +25°C
60V	6.2mΩ @ V <sub>GS</sub> = 10V	82A
	8.5mΩ @ V <sub>GS</sub> = 4.5V	70A

## **Description and Applications**

This MOSFET is designed to minimize the on-state resistance  $(R_{DS(ON)})$  yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

#### • Synchronous Rectifier

- DC-DC Converters
- Power Management

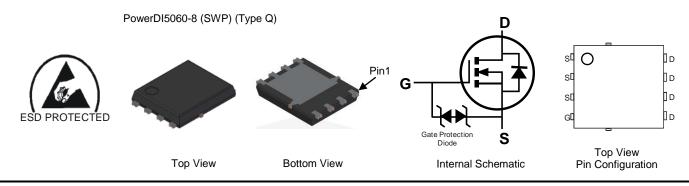
## 60V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

#### Features

- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application.
- High Conversion Efficiency
- Low R<sub>DS(ON)</sub>—Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Wettable Flank for Improved Optical Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

# **Mechanical Data**

- Case: PowerDI<sup>®</sup>5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish—Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)



# Ordering Information (Note 4)

Part Number	Case	Packaging
DMT67M8LPSW-13	PowerDI5060-8 (SWP) (Type Q)	2500 / Tape & Reel

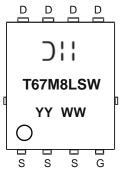
Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



D'L' = Manufacturer's Marking T67M8LSW = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 19 = 2019) WW = Week Code (01 to 53)



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V <sub>DSS</sub>	60	V	
Gate-Source Voltage	V <sub>GSS</sub>	±20	V	
	T <sub>A</sub> = +25°C		17.3	A
Continuous Drain Current (Note 5) $V_{GS} = 10V$	T <sub>A</sub> = +70°C	ID	13.8	
	T <sub>C</sub> = +25°C	1	82	А
Continuous Drain Current (Note 6) $V_{GS} = 10V$	T <sub>C</sub> = +70°C	ID	65.6	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	320	A	
Maximum Continuous Body Diode Forward Current (Note 6)	Is	82	A	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	I <sub>SM</sub>	320	A	
Avalanche Current, L = 0.3mH		I <sub>AS</sub>	23.7	A
Avalanche Energy, L = 0.3mH		E <sub>AS</sub>	84.5	mJ

# **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	2.8	W
Thermal Resistance, Junction to Ambient (Note 5)		R <sub>0JA</sub>	45	°C/W
Total Power Dissipation (Note 6)	T <sub>C</sub> = +25°C	PD	62.5	W
Thermal Resistance, Junction to Case (Note 6)		R <sub>θJC</sub>	2	°C/W
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)						•	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	—	—	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	—	1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	—	—	±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.2	1.64	2.5	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	P	—	4.4	6.2	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	—	6.2	8.5	11152	$V_{GS} = 4.5V, I_D = 20A$	
Diode Forward Voltage	V <sub>SD</sub>	—	0.7	1.2	V	$V_{GS} = 0V, I_S = 1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	2130			$V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz	
Output Capacitance	Coss	_	786		pF		
Reverse Transfer Capacitance	C <sub>rss</sub>	—	70	—			
Gate Resistance	Rg	—	0.6		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	—	20	_			
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	—	37.5	—	nC	$V_{DS} = 30V, I_{D} = 20A$	
Gate-Source Charge	Q <sub>gs</sub>	—	5.4	_	110	$v_{DS} = 30v, I_{D} = 20A$	
Gate-Drain Charge	Q <sub>gd</sub>	—	9.5	—			
Turn-On Delay Time	t <sub>D(ON)</sub>	—	5.5	—		$V_{DD} = 30V, V_{GS} = 10V,$ $I_D = 20A, R_g = 3\Omega$	
Turn-On Rise Time	t <sub>R</sub>	_	6.8	_			
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	22.1		ns		
Turn-Off Fall Time	tF	_	10.8			-	
Reverse Recovery Time	t <sub>RR</sub>	_	26.9	_	ns		
Reverse Recovery Charge	Q <sub>RR</sub>	_	56.8	_	nC	I <sub>F</sub> = 20A, di/dt = 300A/μs	

Notes:

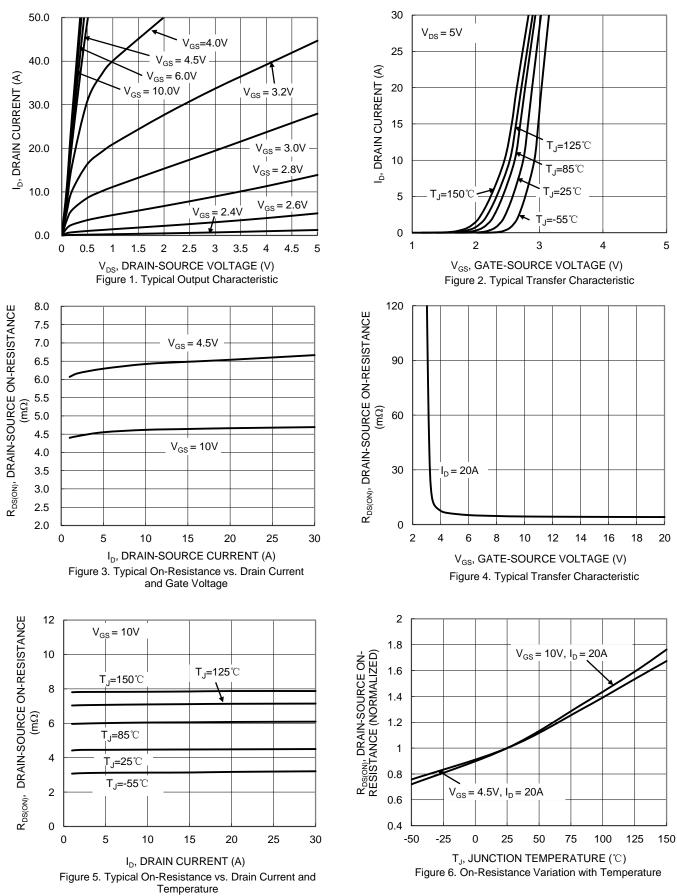
5. Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).

7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to product testing.

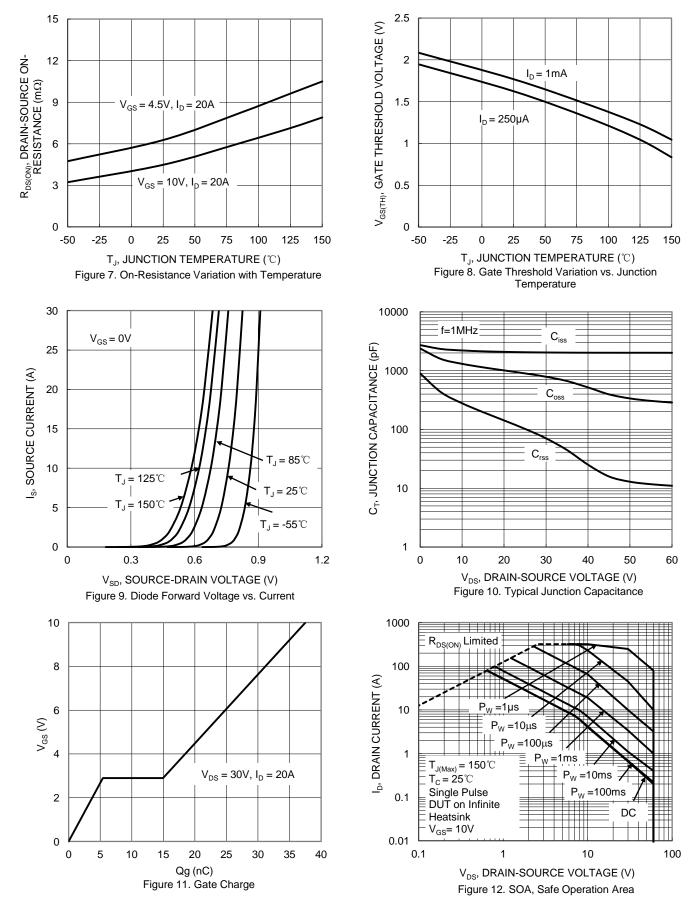


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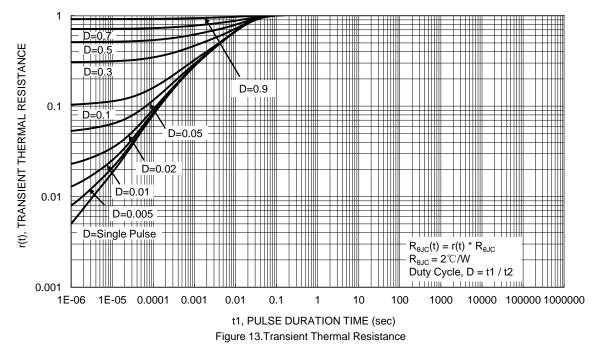




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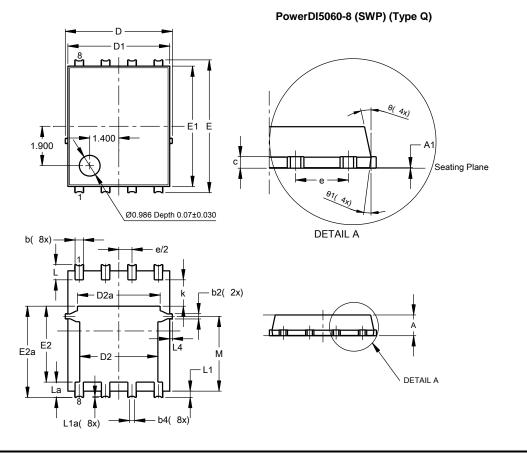






# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

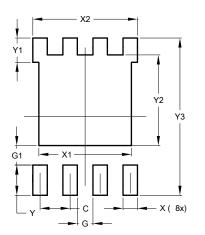


PowerDI5060-8 (SWP)						
	(Type Q)					
Dim	Min	Max	Тур			
Α	0.90	1.10	1.00			
A1	0	0.05				
b	0.30	0.50	0.41			
b2	0.20	0.35	0.25			
b4	C	).25REF				
С	0.230	0.330	0.277			
D	-	.15 BS0	2			
D1	4.70	5.10	4.90			
D2	3.56	3.96	3.76			
D2a	3.78	4.18	3.98			
E	6	.40 BS0	2			
E1	5.60	6.00	5.80			
E2	3.46	3.86	3.66			
E2a	4.195	4.595	4.395			
е	1	.27BSC	)			
k	1.05					
L	0.635	0.835	0.735			
La	0.635	0.835	0.735			
L1	0.200	0.400	0.300			
L1a	0.050REF					
L4	0.025	0.225	0.125			
М	3.205	4.005	3.605			
θ	10°	12°	11°			
θ1	6°	8°	7°			
All	All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI5060-8 (SWP) (Type Q)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	4.100		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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